

## High-Speed CMOS Logic 8-Stage Synchronous Down Counters

### Features

- Synchronous or Asynchronous Preset
- Cascadable in Synchronous or Ripple Mode
- Fanout (Over Temperature Range)
  - Standard Outputs . . . . . 10 LSTTL Loads
  - Bus Driver Outputs . . . . . 15 LSTTL Loads
- Wide Operating Temperature Range . . . -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL} = 30\%$ ,  $N_{IH} = 30\%$  of  $V_{CC}$  at  $V_{CC} = 5V$
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility,  $V_{IL} = 0.8V$  (Max),  $V_{IH} = 2V$  (Min)
  - CMOS Input Compatibility,  $I_I \leq 1\mu A$  at  $V_{OL}$ ,  $V_{OH}$

### Ordering Information

| PART NUMBER     | TEMP. RANGE (°C) | PACKAGE      |
|-----------------|------------------|--------------|
| CD54HC40103F3A  | -55 to 125       | 16 Ld CERDIP |
| CD74HC40103E    | -55 to 125       | 16 Ld PDIP   |
| CD74HC40103M    | -55 to 125       | 16 Ld SOIC   |
| CD74HC40103MT   | -55 to 125       | 16 Ld SOIC   |
| CD74HC40103M96  | -55 to 125       | 16 Ld SOIC   |
| CD74HCT40103E   | -55 to 125       | 16 Ld PDIP   |
| CD74HCT40103M   | -55 to 125       | 16 Ld SOIC   |
| CD74HCT40103MT  | -55 to 125       | 16 Ld SOIC   |
| CD74HCT40103M96 | -55 to 125       | 16 Ld SOIC   |

NOTE: When ordering, use the entire part number. The suffix 96 denotes tape and reel. The suffix T denotes a small-quantity reel of 250.

### Description

The 'HC40103 and CD74HCT40103 are manufactured with high speed silicon gate technology and consist of an 8-stage synchronous down counter with a single output which is active when the internal count is zero. The 40103 contains a single 8-bit binary counter. Each has control inputs for enabling or disabling the clock, for clearing the counter to its maximum count, and for presetting the counter either synchronously or asynchronously. All control inputs and the TC output are active-low logic.

In normal operation, the counter is decremented by one count on each positive transition of the CLOCK (CP). Counting is inhibited when the  $\overline{TE}$  input is high. The TC output goes low when the count reaches zero if the  $\overline{TE}$  input is low, and remains low for one full clock period.

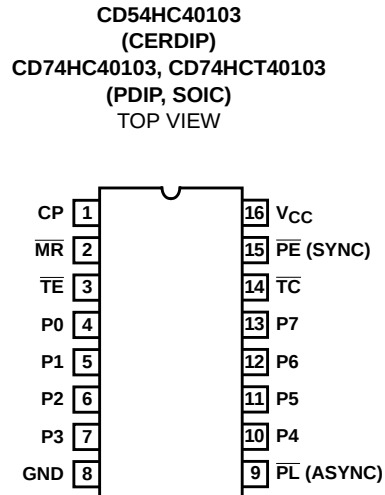
When the  $\overline{PE}$  input is low, data at the P0-P7 inputs are clocked into the counter on the next positive clock transition regardless of the state of the  $\overline{TE}$  input. When the  $\overline{PL}$  input is low, data at the P0-P7 inputs are asynchronously forced into the counter regardless of the state of the  $\overline{PE}$ ,  $\overline{TE}$ , or CLOCK inputs. Input P0-P7 represent a single 8-bit binary word for the 40103. When the MR input is low, the counter is asynchronously cleared to its maximum count of 255<sub>10</sub>, regardless of the state of any other input. The precedence relationship between control inputs is indicated in the truth table.

If all control inputs except  $\overline{TE}$  are high at the time of zero count, the counters will jump to the maximum count, giving a counting sequence of 100<sub>16</sub> or 256<sub>10</sub> clock pulses long.

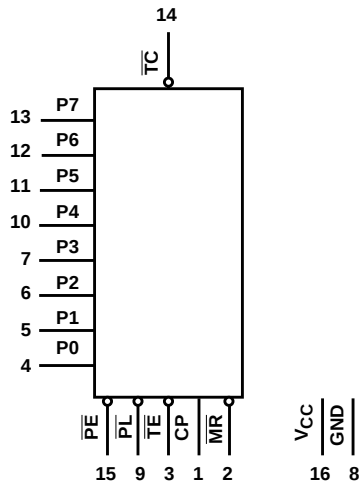
The 40103 may be cascaded using the  $\overline{TE}$  input and the TC output, in either a synchronous or ripple mode. These circuits possess the low power consumption usually associated with CMOS circuitry, yet have speeds comparable to low power Schottky TTL circuits and can drive up to 10 LSTTL loads.

# CD54HC40103, CD74HC40103, CD74HCT40103

## Pinout



## Functional Diagram



TRUTH TABLE

| CONTROL INPUTS |    |    |    | PRESET MODE    | ACTION                                   |
|----------------|----|----|----|----------------|------------------------------------------|
| MR             | PL | PE | TE |                |                                          |
| 1              | 1  | 1  | 1  | Synchronous    | Inhibit Counter                          |
| 1              | 1  | 1  | 0  |                | Count Down                               |
| 1              | 1  | 0  | X  |                | Preset On Next Positive Clock Transition |
| 1              | 0  | X  | X  | Asynchronously | Preset Asynchronously                    |
| 0              | X  | X  | X  |                | Clear to Maximum Count                   |

1 = High Level.

0 = Low Level.

X = Don't Care.

Clock connected to clock input.

Synchronous Operation: changes occur on negative-to-positive clock transitions.

Load Inputs: MSB = P7, LSB = P0.

# CD54HC40103, CD74HC40103, CD74HCT40103

## Absolute Maximum Ratings

|                                                        |             |
|--------------------------------------------------------|-------------|
| DC Supply Voltage, $V_{CC}$                            | -0.5V to 7V |
| DC Input Diode Current, $I_{IK}$                       |             |
| For $V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$             | $\pm 20mA$  |
| DC Output Diode Current, $I_{OK}$                      |             |
| For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$             | $\pm 20mA$  |
| DC Output Source or Sink Current per Output Pin, $I_O$ |             |
| For $V_O > -0.5V$ or $V_O < V_{CC} + 0.5V$             | $\pm 25mA$  |
| DC $V_{CC}$ or Ground Current, $I_{CC}$                | $\pm 50mA$  |

## Thermal Information

|                                          |                                    |
|------------------------------------------|------------------------------------|
| Thermal Resistance (Typical, Note 1)     | $\theta_{JA}$ ( $^{\circ}C/W$ )    |
| E (PDIP) Package                         | 67                                 |
| M (SOIC) Package                         | 73                                 |
| Maximum Junction Temperature             | 150 $^{\circ}C$                    |
| Maximum Storage Temperature Range        | -65 $^{\circ}C$ to 150 $^{\circ}C$ |
| Maximum Lead Temperature (Soldering 10s) | 300 $^{\circ}C$                    |
| (SOIC - Lead Tips Only)                  |                                    |

## Operating Conditions

|                                           |                                    |
|-------------------------------------------|------------------------------------|
| Temperature Range, $T_A$                  | -55 $^{\circ}C$ to 125 $^{\circ}C$ |
| Supply Voltage Range, $V_{CC}$            |                                    |
| HC Types                                  | .2V to 6V                          |
| HCT Types                                 | 4.5V to 5.5V                       |
| DC Input or Output Voltage, $V_I$ , $V_O$ | 0V to $V_{CC}$                     |
| Input Rise and Fall Time                  |                                    |
| 2V                                        | 1000ns (Max)                       |
| 4.5V                                      | 500ns (Max)                        |
| 6V                                        | 400ns (Max)                        |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

## DC Electrical Specifications

| PARAMETER                               | SYMBOL          | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |      |      | -40°C TO 85°C |      | -55°C TO 125°C |      | UNITS |
|-----------------------------------------|-----------------|------------------------------------|---------------------|---------------------|------|------|------|---------------|------|----------------|------|-------|
|                                         |                 | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP  | MAX  | MIN           | MAX  | MIN            | MAX  |       |
| HC TYPES                                |                 |                                    |                     |                     |      |      |      |               |      |                |      |       |
| High Level Input Voltage                | V <sub>IH</sub> | -                                  | -                   | 2                   | 1.5  | -    | -    | 1.5           | -    | 1.5            | -    | V     |
|                                         |                 |                                    |                     | 4.5                 | 3.15 | -    | -    | 3.15          | -    | 3.15           | -    | V     |
|                                         |                 |                                    |                     | 6                   | 4.2  | -    | -    | 4.2           | -    | 4.2            | -    | V     |
| Low Level Input Voltage                 | V <sub>IL</sub> | -                                  | -                   | 2                   | -    | -    | 0.5  | -             | 0.5  | -              | 0.5  | V     |
|                                         |                 |                                    |                     | 4.5                 | -    | -    | 1.35 | -             | 1.35 | -              | 1.35 | V     |
|                                         |                 |                                    |                     | 6                   | -    | -    | 1.8  | -             | 1.8  | -              | 1.8  | V     |
| High Level Output Voltage<br>CMOS Loads | V <sub>OH</sub> | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 2                   | 1.9  | -    | -    | 1.9           | -    | 1.9            | -    | V     |
|                                         |                 |                                    | -0.02               | 4.5                 | 4.4  | -    | -    | 4.4           | -    | 4.4            | -    | V     |
|                                         |                 |                                    | -0.02               | 6                   | 5.9  | -    | -    | 5.9           | -    | 5.9            | -    | V     |
| -                                       |                 |                                    | -                   | -                   | -    | -    | -    | -             | -    | -              | V    |       |
| -                                       |                 |                                    | 4.5                 | 3.98                | -    | -    | 3.84 | -             | 3.7  | -              | V    |       |
| -5.2                                    |                 |                                    | 6                   | 5.48                | -    | -    | 5.34 | -             | 5.2  | -              | V    |       |
| High Level Output Voltage<br>TTL Loads  | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2                   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                    | 0.02                | 4.5                 | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
|                                         |                 |                                    | 0.02                | 6                   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| -                                       |                 |                                    | -                   | -                   | -    | -    | -    | -             | -    | -              | V    |       |
| 4                                       |                 |                                    | 4.5                 | -                   | -    | 0.26 | -    | 0.33          | -    | 0.4            | V    |       |
| 5.2                                     |                 |                                    | 6                   | -                   | -    | 0.26 | -    | 0.33          | -    | 0.4            | V    |       |
| Low Level Output Voltage<br>CMOS Loads  | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 2                   | -    | -    | 0.1  | -             | 0.1  | -              | 0.1  | V     |
| 0.02                                    |                 |                                    | 4.5                 | -                   | -    | 0.1  | -    | 0.1           | -    | 0.1            | V    |       |
| 0.02                                    |                 |                                    | 6                   | -                   | -    | 0.1  | -    | 0.1           | -    | 0.1            | V    |       |
| Low Level Output Voltage<br>TTL Loads   | V <sub>OL</sub> | V <sub>IH</sub> or V <sub>IL</sub> | -                   | -                   | -    | -    | -    | -             | -    | -              | -    | V     |
|                                         |                 |                                    | 4                   | 4.5                 | -    | -    | 0.26 | -             | 0.33 | -              | 0.4  | V     |
|                                         |                 |                                    | 5.2                 | 6                   | -    | -    | 0.26 | -             | 0.33 | -              | 0.4  | V     |
| Input Leakage Current                   | I <sub>I</sub>  | V <sub>CC</sub> or GND             | -                   | 6                   | -    | -    | ±0.1 | -             | ±1   | -              | ±1   | µA    |
| Quiescent Device Current                | I <sub>CC</sub> | V <sub>CC</sub> or GND             | 0                   | 6                   | -    | -    | 8    | -             | 80   | -              | 160  | µA    |

**CD54HC40103, CD74HC40103, CD74HCT40103**

**DC Electrical Specifications (Continued)**

| PARAMETER                                                      | SYMBOL                    | TEST CONDITIONS                    |                     | V <sub>CC</sub> (V) | 25°C |     |      | -40°C TO 85°C |      | -55°C TO 125°C |     | UNITS |
|----------------------------------------------------------------|---------------------------|------------------------------------|---------------------|---------------------|------|-----|------|---------------|------|----------------|-----|-------|
|                                                                |                           | V <sub>I</sub> (V)                 | I <sub>O</sub> (mA) |                     | MIN  | TYP | MAX  | MIN           | MAX  | MIN            | MAX |       |
| HCT TYPES                                                      |                           |                                    |                     |                     |      |     |      |               |      |                |     |       |
| High Level Input Voltage                                       | V <sub>IH</sub>           | -                                  | -                   | 4.5 to 5.5          | 2    | -   | -    | 2             | -    | 2              | -   | V     |
| Low Level Input Voltage                                        | V <sub>IL</sub>           | -                                  | -                   | 4.5 to 5.5          | -    | -   | 0.8  | -             | 0.8  | -              | 0.8 | V     |
| High Level Output Voltage<br>CMOS Loads                        | V <sub>OH</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | -0.02               | 4.5                 | 4.4  | -   | -    | 4.4           | -    | 4.4            | -   | V     |
| High Level Output Voltage<br>TTL Loads                         |                           |                                    | -4                  | 4.5                 | 3.98 | -   | -    | 3.84          | -    | 3.7            | -   | V     |
| Low Level Output Voltage<br>CMOS Loads                         | V <sub>OL</sub>           | V <sub>IH</sub> or V <sub>IL</sub> | 0.02                | 4.5                 | -    | -   | 0.1  | -             | 0.1  | -              | 0.1 | V     |
| Low Level Output Voltage<br>TTL Loads                          |                           |                                    | 4                   | 4.5                 | -    | -   | 0.26 | -             | 0.33 | -              | 0.4 | V     |
| Input Leakage Current                                          | I <sub>I</sub>            | V <sub>CC</sub> and GND            | 0                   | 5.5                 | -    | -   | ±0.1 | -             | ±1   | -              | ±1  | μA    |
| Quiescent Device Current                                       | I <sub>CC</sub>           | V <sub>CC</sub> or GND             | 0                   | 5.5                 | -    | -   | 8    | -             | 80   | -              | 160 | μA    |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI <sub>CC</sub> (Note 2) | V <sub>CC</sub> -2.1               | -                   | 4.5 to 5.5          | -    | 100 | 360  | -             | 450  | -              | 490 | μA    |

NOTE:

- For dual-supply systems theoretical worst case (V<sub>I</sub> = 2.4V, V<sub>CC</sub> = 5.5V) specification is 1.8mA.

**HCT Input Loading Table**

| INPUT  | UNIT LOADS (NOTE) |
|--------|-------------------|
| P0-P7  | 0.20              |
| TE, MR | 0.40              |
| CP     | 0.60              |
| PE     | 0.80              |
| PL     | 1.35              |

NOTE: Unit Load is ΔI<sub>CC</sub> limit specified in DC Electrical Table, e.g., 360μA max at 25°C.

**Prerequisite for Switching Specifications**

| PARAMETER      | SYMBOL         | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|----------------|----------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                |                |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| HC TYPES       |                |                     |      |     |     |               |     |                |     |       |
| CP Pulse Width | t <sub>W</sub> | 2                   | 165  | -   | -   | 205           | -   | 250            | -   | ns    |
|                |                | 4.5                 | 33   | -   | -   | 41            | -   | 50             | -   | ns    |
|                |                | 6                   | 28   | -   | -   | 35            | -   | 43             | -   | ns    |
| PL Pulse Width | t <sub>W</sub> | 2                   | 125  | -   | -   | 155           | -   | 190            | -   | ns    |
|                |                | 4.5                 | 25   | -   | -   | 31            | -   | 38             | -   | ns    |
|                |                | 6                   | 21   | -   | -   | 26            | -   | 32             | -   | ns    |

**CD54HC40103, CD74HC40103, CD74HCT40103**

**Prerequisite for Switching Specifications (Continued)**

| PARAMETER                                                     | SYMBOL               | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|---------------------------------------------------------------|----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                                                               |                      |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| MR Pulse Width                                                | t <sub>W</sub>       | 2                   | 125  | -   | -   | 135           | -   | 190            | -   | ns    |
|                                                               |                      | 4.5                 | 25   | -   | -   | 31            | -   | 38             | -   | ns    |
|                                                               |                      | 6                   | 21   | -   | -   | 26            | -   | 32             | -   | ns    |
| CP Max. Frequency<br>(Note 3)                                 | f <sub>CP(MAX)</sub> | 2                   | 3    | -   | -   | 2             | -   | 2              | -   | MHz   |
|                                                               |                      | 4.5                 | 15   | -   | -   | 12            | -   | 10             | -   | MHz   |
|                                                               |                      | 6                   | 18   | -   | -   | 14            | -   | 12             | -   | MHz   |
| P to CP Set-up Time                                           | t <sub>SU</sub>      | 2                   | 100  | -   | -   | 125           | -   | 150            | -   | ns    |
|                                                               |                      | 4.5                 | 20   | -   | -   | 25            | -   | 30             | -   | ns    |
|                                                               |                      | 6                   | 17   | -   | -   | 21            | -   | 26             | -   | ns    |
| P $\overline{\text{E}}$ to CP Set-up Time                     | t <sub>SU</sub>      | 2                   | 75   | -   | -   | 95            | -   | 110            | -   | ns    |
|                                                               |                      | 4.5                 | 15   | -   | -   | 19            | -   | 22             | -   | ns    |
|                                                               |                      | 6                   | 13   | -   | -   | 16            | -   | 19             | -   | ns    |
| T $\overline{\text{E}}$ to CP Set-up Time                     | t <sub>SU</sub>      | 2                   | 150  | -   | -   | 190           | -   | 225            | -   | ns    |
|                                                               |                      | 4.5                 | 30   | -   | -   | 38            | -   | 45             | -   | ns    |
|                                                               |                      | 6                   | 26   | -   | -   | 33            | -   | 38             | -   | ns    |
| P to CP Hold Time                                             | t <sub>H</sub>       | 2                   | 5    | -   | -   | 5             | -   | 5              | -   | ns    |
|                                                               |                      | 4.5                 | 5    | -   | -   | 5             | -   | 5              | -   | ns    |
|                                                               |                      | 6                   | 5    | -   | -   | 5             | -   | 5              | -   | ns    |
| T $\overline{\text{E}}$ to $\overline{\text{CP}}$ Hold Time   | t <sub>H</sub>       | 2                   | 0    | -   | -   | 0             | -   | 0              | -   | ns    |
|                                                               |                      | 4.5                 | 0    | -   | -   | 0             | -   | 0              | -   | ns    |
|                                                               |                      | 6                   | 0    | -   | -   | 0             | -   | 0              | -   | ns    |
| MR to CP Removal Time                                         | t <sub>REM</sub>     | 2                   | 50   | -   | -   | 65            | -   | 75             | -   | ns    |
|                                                               |                      | 4.5                 | 10   | -   | -   | 13            | -   | 15             | -   | ns    |
|                                                               |                      | 6                   | 9    | -   | -   | 11            | -   | 13             | -   | ns    |
| P $\overline{\text{E}}$ to $\overline{\text{CP}}$ Hold Time   | t <sub>H</sub>       | 2                   | 2    | -   | -   | 2             | -   | 2              | -   | ns    |
|                                                               |                      | 4.5                 | 2    | -   | -   | 2             | -   | 2              | -   | ns    |
|                                                               |                      | 6                   | 2    | -   | -   | 2             | -   | 2              | -   | ns    |
| HCT TYPES                                                     |                      |                     |      |     |     |               |     |                |     |       |
| CP Pulse Width                                                | t <sub>W</sub>       | 4.5                 | 35   | -   | -   | 44            | -   | 53             | -   | ns    |
| P $\overline{\text{L}}$ Pulse Width                           | t <sub>W</sub>       | 4.5                 | 43   | -   | -   | 54            | -   | 65             | -   | ns    |
| $\overline{\text{MR}}$ Pulse Width                            | t <sub>W</sub>       | 4.5                 | 35   | -   | -   | 44            | -   | 53             | -   | ns    |
| CP Max. Frequency<br>(Note 3)                                 | f <sub>CP(MAX)</sub> | 4.5                 | 14   | -   | -   | 11            | -   | 9              | -   | MHz   |
| P to CP Set-up Time                                           | t <sub>SU</sub>      | 4.5                 | 24   | -   | -   | 30            | -   | 36             | -   | ns    |
| P $\overline{\text{E}}$ to CP Set-up Time                     | t <sub>SU</sub>      | 4.5                 | 20   | -   | -   | 25            | -   | 30             | -   | ns    |
| T $\overline{\text{E}}$ to CP Set-up Time                     | t <sub>SU</sub>      | 4.5                 | 40   | -   | -   | 50            | -   | 60             | -   | ns    |
| P to CP Hold Time                                             | t <sub>H</sub>       | 4.5                 | 5    | -   | -   | 5             | -   | 5              | -   | ns    |
| T $\overline{\text{E}}$ to $\overline{\text{CP}}$ Hold Time   | t <sub>H</sub>       | 4.5                 | 0    | -   | -   | 0             | -   | 0              | -   | ns    |
| $\overline{\text{MR}}$ to $\overline{\text{CP}}$ Removal Time | t <sub>REM</sub>     | 4.5                 | 10   | -   | -   | 13            | -   | 15             | -   | ns    |
| P $\overline{\text{E}}$ to $\overline{\text{CP}}$ Hold Time   | t <sub>H</sub>       | 4.5                 | 2    | -   | -   | 2             | -   | 2              | -   | ns    |

**CD54HC40103, CD74HC40103, CD74HCT40103**

**Switching Specifications** Input  $t_r, t_f = 6\text{ns}$

| PARAMETER                                                     | SYMBOL             | TEST CONDITIONS       | V <sub>CC</sub> (V) | 25°C |     |     | -40°C TO 85°C |     | -55°C TO 125°C |     | UNITS |
|---------------------------------------------------------------|--------------------|-----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
|                                                               |                    |                       |                     | MIN  | TYP | MAX | MIN           | MAX | MIN            | MAX |       |
| HC TYPES                                                      |                    |                       |                     |      |     |     |               |     |                |     |       |
| Propagation Delay<br>CP to any $\overline{TC}$ (Async Preset) | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 300 | -             | 375 | -              | 450 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 60  | -             | 75  | -              | 90  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 25  | -   | -             | -   | -              | -   | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 51  | -             | 64  | -              | 77  | ns    |
| CP to $\overline{TC}$ (Sync Preset)                           | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 300 | -             | 375 | -              | 450 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 60  | -             | 75  | -              | 90  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 25  | -   | -             | -   | -              | -   | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 51  | -             | 64  | -              | 77  | ns    |
| $\overline{TE}$ to $\overline{TC}$                            | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 200 | -             | 250 | -              | 300 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 40  | -             | 50  | -              | 60  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 17  | -   | -             | -   | -              | -   | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 34  | -             | 43  | -              | 51  | ns    |
| $\overline{PL}$ to $\overline{TC}$                            | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 275 | -             | 345 | -              | 415 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 55  | -             | 69  | -              | 83  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 23  | -   | -             | -   | -              | -   | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 47  | -             | 59  | -              | 71  | ns    |
| $\overline{MR}$ to $\overline{TC}$                            | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 275 | -             | 345 | -              | 415 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 55  | -             | 69  | -              | 83  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 23  | -   | -             | -   | -              | -   | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 47  | -             | 59  | -              | 71  | ns    |
| Output Transition Time                                        | $t_{TLH}, t_{THL}$ | C <sub>L</sub> = 50pF | 2                   | -    | -   | 75  | -             | 95  | -              | 110 | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 15  | -             | 19  | -              | 22  | ns    |
|                                                               |                    | C <sub>L</sub> = 50pF | 6                   | -    | -   | 13  | -             | 16  | -              | 19  | ns    |
| Input Capacitance                                             | C <sub>I</sub>     | C <sub>L</sub> = 50pF | -                   | -    | -   | 10  | -             | 10  | -              | 10  | pF    |
| CP Maximum Frequency                                          | f <sub>MAX</sub>   | C <sub>L</sub> = 15pF | 5                   | -    | 25  | -   | -             | -   | -              | -   | MHz   |
| Power Dissipation Capacitance<br>(Notes 4, 5)                 | C <sub>PD</sub>    | -                     | 5                   | -    | 25  | -   | -             | -   | -              | -   | pF    |
| HCT TYPES                                                     |                    |                       |                     |      |     |     |               |     |                |     |       |
| Propagation Delay<br>CP to $\overline{TC}$ (Async Preset)     | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 60  | -             | 75  | -              | 90  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 25  | -   | -             | -   | -              | -   | ns    |
| $\overline{CE}$ to $\overline{TC}$ (Sync Preset)              | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 63  | -             | 79  | -              | 95  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 26  | -   | -             | -   | -              | -   | ns    |
| $\overline{TE}$ to $\overline{TC}$                            | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 50  | -             | 63  | -              | 75  | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 21  | -   | -             | -   | -              | -   | ns    |
| $\overline{PL}$ to $\overline{TC}$                            | $t_{PLH}, t_{PHL}$ | C <sub>L</sub> = 50pF | 4.5                 | -    | -   | 68  | -             | 85  | -              | 102 | ns    |
|                                                               |                    | C <sub>L</sub> = 15pF | 5                   | -    | 28  | -   | -             | -   | -              | -   | ns    |

# CD54HC40103, CD74HC40103, CD74HCT40103

## Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

| PARAMETER                                     | SYMBOL             | TEST CONDITIONS     | $V_{CC}$<br>(V) | 25°C |     |     | -40°C TO<br>85°C |     | -55°C TO<br>125°C |     | UNITS |
|-----------------------------------------------|--------------------|---------------------|-----------------|------|-----|-----|------------------|-----|-------------------|-----|-------|
|                                               |                    |                     |                 | MIN  | TYP | MAX | MIN              | MAX | MIN               | MAX |       |
| $\overline{MR}$ to $\overline{TC}$            | $t_{PLH}, t_{PHL}$ | $C_L = 50\text{pF}$ | 4.5             | -    | -   | 55  | -                | 69  | -                 | 83  | ns    |
|                                               |                    | $C_L = 15\text{pF}$ | 5               | -    | 23  | -   | -                | -   | -                 | -   | ns    |
| Output Transition Time                        | $t_{THL}, t_{TLH}$ | $C_L = 50\text{pF}$ | 4.5             | -    | -   | 15  | -                | 19  | -                 | 22  | ns    |
| Input Capacitance                             | $C_{IN}$           | $C_L = 50\text{pF}$ | -               | -    | -   | 10  | -                | 10  | -                 | 10  | pF    |
| CP Maximum Frequency                          | $f_{MAX}$          | $C_L = 15\text{pF}$ | 5               | -    | 25  | -   | -                | -   | -                 | -   | MHz   |
| Power Dissipation Capacitance<br>(Notes 4, 5) | $C_{PD}$           | -                   | 5               | -    | 27  | -   | -                | -   | -                 | -   | pF    |

### NOTES:

- Noncascaded operation only. With cascaded counters clock-to-terminal count propagation delays, count enables ( $\overline{PE}$  or  $\overline{TE}$ )-to-clock SET UP TIMES, and count enables ( $\overline{PE}$  or  $\overline{TE}$ )-to-clock HOLD TIMES determine maximum clock frequency. For example, with these HC devices:

$$C_P f_{MAX} = \frac{1}{\text{CP-to-}\overline{TC} \text{ prop delay} + \overline{TE}\text{-to-CP Setup Time} + \overline{TE}\text{-to-CP Hold Time}} = \frac{1}{60 + 30 + 0} \approx 11\text{MHz}$$

- $C_{PD}$  is used to determine the dynamic power consumption, per package.
- $P_D = V_{CC}^2 f_i + C_L V_{CC}^2 f_o$  where  $f_i$  = Input Frequency,  $C_L$  = Output Load Capacitance,  $V_{CC}$  = Supply Voltage,  $f_o$  = Output Frequency.

## Timing Diagrams

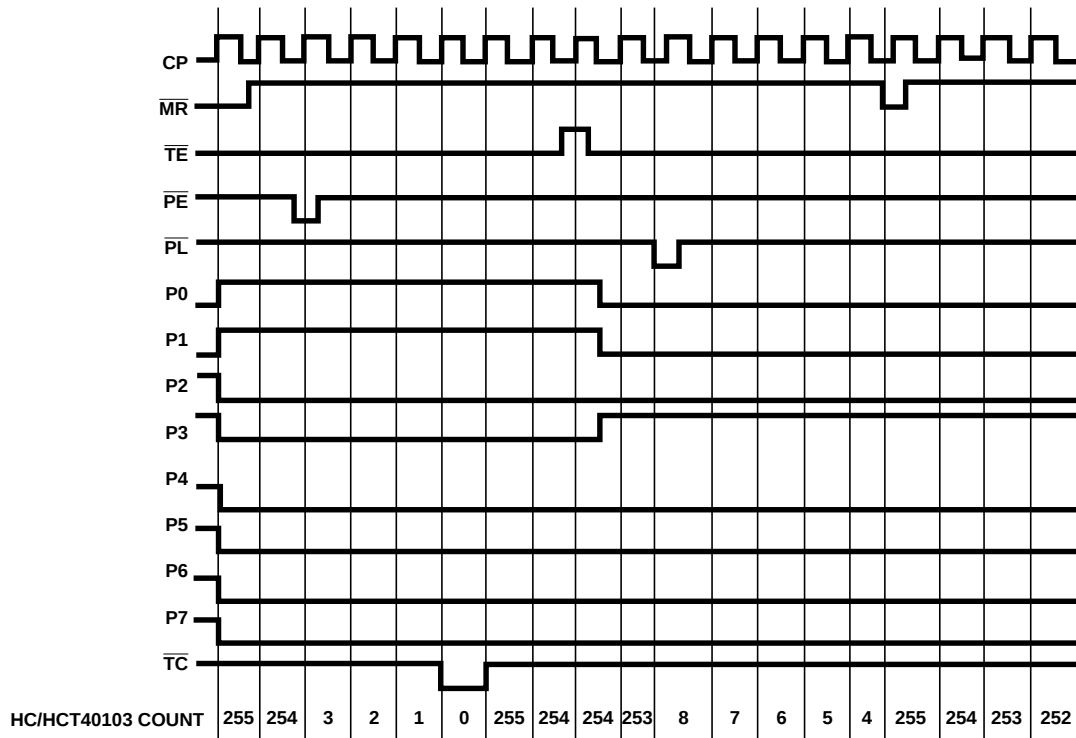


FIGURE 1.

## Test Circuits and Waveforms

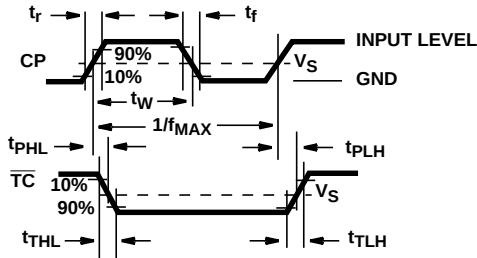


FIGURE 2.

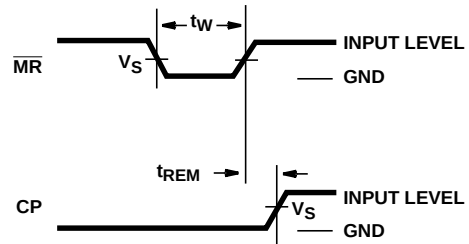


FIGURE 3.

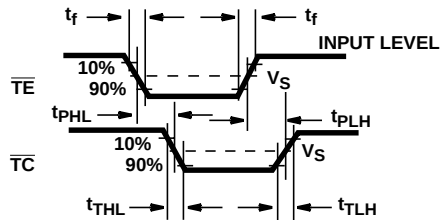


FIGURE 4.

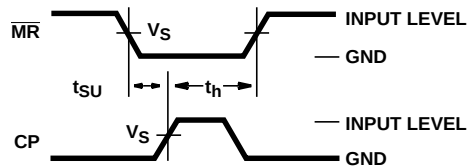


FIGURE 5.

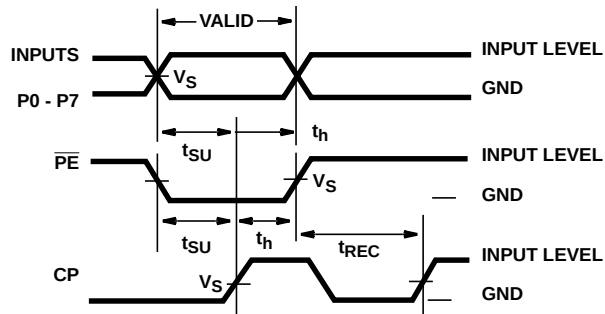


FIGURE 6.

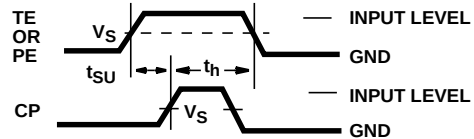
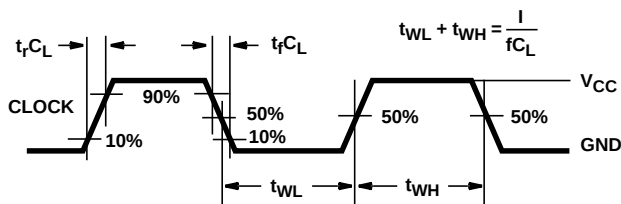
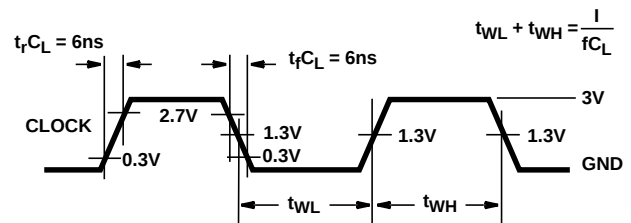


FIGURE 7.



NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

FIGURE 8. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH



NOTE: Outputs should be switching from 10%  $V_{CC}$  to 90%  $V_{CC}$  in accordance with device truth table. For  $f_{MAX}$ , input duty cycle = 50%.

FIGURE 9. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH

**PACKAGING INFORMATION**

| Orderable Device  | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup>    | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|-------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| 5962-9055301EA    | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                        | Call TI              | Call TI                      |                             |
| 5HC40103F3AS228   | OBSOLETE              | CDIP         | J               | 16   |             | TBD                        | Call TI              | Call TI                      |                             |
| CD54HC40103F      | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| CD54HC40103F3A    | ACTIVE                | CDIP         | J               | 16   | 1           | TBD                        | A42                  | N / A for Pkg Type           |                             |
| CD74HC40103E      | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           |                             |
| CD74HC40103EE4    | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           |                             |
| CD74HC40103M      | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103M96    | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103M96E4  | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103M96G4  | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103ME4    | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103MG4    | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103MT     | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103MTE4   | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HC40103MTG4   | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103E     | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           |                             |
| CD74HCT40103EE4   | ACTIVE                | PDIP         | N               | 16   | 25          | Pb-Free (RoHS)             | CU NIPDAU            | N / A for Pkg Type           |                             |
| CD74HCT40103M     | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103M96   | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103M96E4 | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS<br>& no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

| Orderable Device  | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/<br>Ball Finish | MSL Peak Temp <sup>(3)</sup> | Samples<br>(Requires Login) |
|-------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| CD74HCT40103M96G4 | ACTIVE                | SOIC         | D               | 16   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103ME4   | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103MG4   | ACTIVE                | SOIC         | D               | 16   | 40          | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103MT    | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103MTE4  | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |
| CD74HCT40103MTG4  | ACTIVE                | SOIC         | D               | 16   | 250         | Green (RoHS & no Sb/Br) | CU NIPDAU            | Level-1-260C-UNLIM           |                             |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**OTHER QUALIFIED VERSIONS OF CD54HC40103, CD74HC40103 :**

- Catalog: [CD74HC40103](#)
- Automotive: [CD74HC40103-Q1](#), [CD74HC40103-Q1](#)
- Enhanced Product: [CD74HC40103-EP](#), [CD74HC40103-EP](#)
- Military: [CD54HC40103](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
- Military - QML certified for Military and Defense Applications

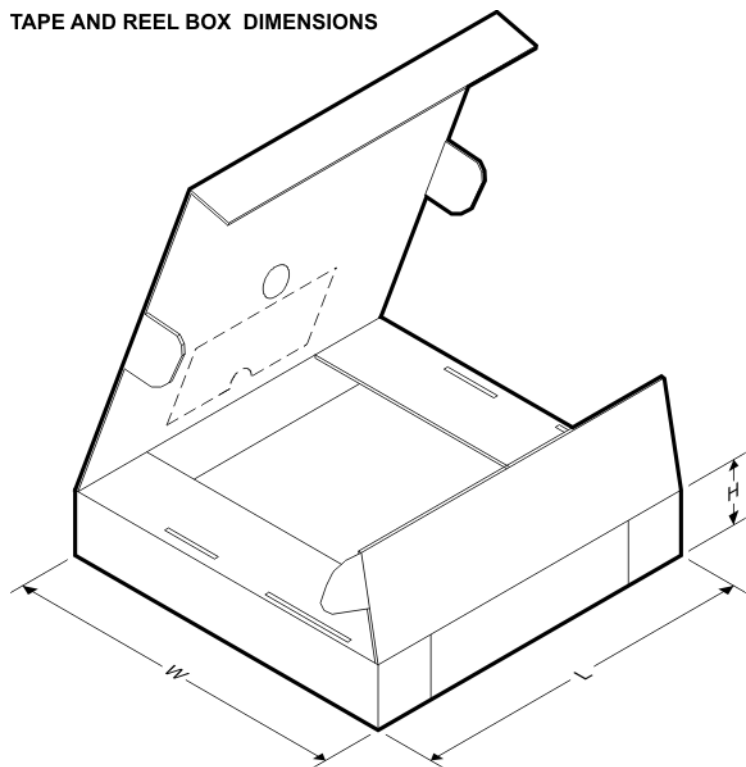
**TAPE AND REEL INFORMATION**



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CD74HC40103M96  | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |
| CD74HCT40103M96 | SOIC         | D               | 16   | 2500 | 330.0              | 16.4               | 6.5     | 10.3    | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC40103M96  | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |
| CD74HCT40103M96 | SOIC         | D               | 16   | 2500 | 333.2       | 345.9      | 28.6        |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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### Products

|                        |                                                                                      |
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|                               |                                                                                          |
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